# **AN7213**

### FM Front-end Circuit for Radio

### Description

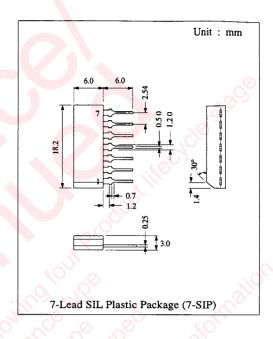
The AN7213 is a monolithic integrated circuit designed for FM front-end of the portable radio.

#### ■ Features

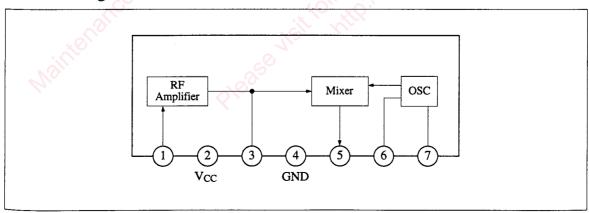
- Built-in RF amplifier, frequency converter, local oscillator
- Wide operating voltage range: 2V~7V
- Low current consumption:  $2mA (V_{CC} = 4V)$

#### ■ Pin

Pin No.	Pin Name				
1	RF Input				
2	Vcc				
3	RF Output				
4	GND				
5	Mixer Output				
б	Oscillator Collector				
7	Oscillator Emitter				



## ■ Block Diagram



### ■ Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Rating	Unit
Supply Voltage	V <sub>CC</sub>	7	V
	V <sub>3-4</sub>	14	V
Terminal Voltage	V <sub>5-4</sub>	14	V
	V <sub>6-4</sub>	14	V
Power Dissipation	P <sub>D</sub>	30	mW
Operating Ambient Temperature	Topr	-20 ~ +75	°C
Storage Temperature	Tstg	-55 ~ +125	°C

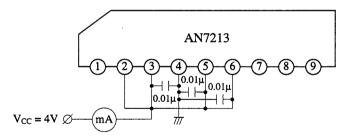
Operating Supply Voltage Range:  $V_{CC} = 2.0V \sim 7.0V$ 

### ■ Electrical Characteristics (Ta=25°C)

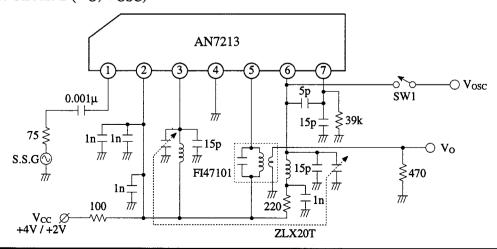
Item	Symbol	Test Circuit	Condition	min.	typ.	max.	Unit
Quiescent Current	$I_{CQ}$	1	$V_{CC} = 4V$ , without signal	1.4		2.55	mA
Output Voltage	Vo	2	$V_{CC} = 4V$ , $V_{in} = 70$ dB $\mu$ , 106MHz*	30.5		68.5	mV
Local Oscillation Voltage	Vosc	2	$V_{CC} = 2V$	130			mV

<sup>\*</sup> Max. output voltage value is obtained by changing input signal frequency ±∆f at 106MHz

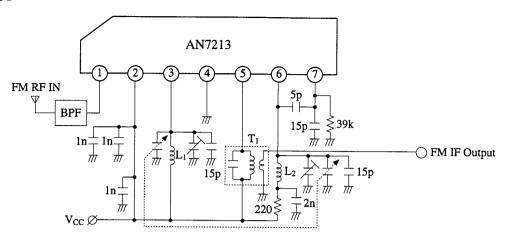
### Test Circuit 1 (Itot)



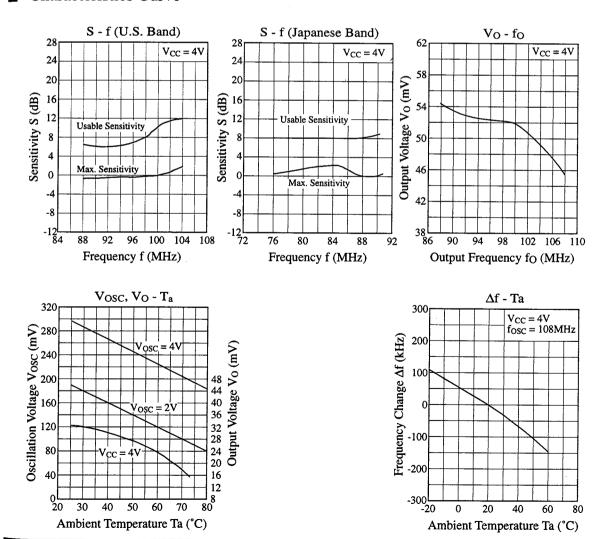
### Test Circuit 2 (Vo, Vosc)



#### Application Circuit



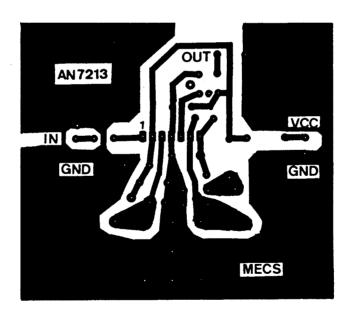
#### Characteristics Curve



## ■ Coil Specifications

Symbol	Use, Freq.	Type No.	Maker	Connection Diagram	Number of Turns	Tuning Cap.	Unloaded Q
T <sub>1</sub>	FM Quad Coil 10.7MHz	EIF-7S752A	Matsushita		① · · · ② · 8T ② · · · ③ · 5T ④ · · · ⑥ · 2T	100pF	90
Lı	RF Coil 76 ~ 108MHz	ELQ-5N53	Matsushita	(P)	⑤ (F) 2.5T	0.0986µH	110 (at 25.2MHz)
L <sub>2</sub>	OSC Coil	ELQ-5N111	Matsushita	(F) (S)	⑤ (Ē) 1.75T	0.0495µH	150 (at 25.2MHz)

## ■ Printed Circuit Board Layout (Scale: 1:1)



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